

Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I verily believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

DESIGNING METHODS AND CIRCUITS FOR MULTIBAND ELECTRONIC CIRCUITS
the specification of which

(check one)

☒ is attached hereto.

☐ was filed on _____ as
Application Serial No. _____
and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the Office all information known to me to be material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56(a).

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
<u>91135334</u>	<u>Taiwan</u>	<u>05/December/2002</u>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
<u>91136641</u>	<u>Taiwan</u>	<u>19/December/2002</u>	<input checked="" type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
_____	_____	_____	<input type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of title 35, United States Code, §112, I acknowledge the duty to disclose to the Office all information known to me to be material to patentability of the application as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

(Status)

(patented, pending, abandoned)

(Application Serial No.)

(Filing Date)

(Status)

(patented, pending, abandoned)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

See Attachment

Send Correspondence to Silicon Valley Patent Group LLP
2350 Mission College Blvd, Suite 360, Santa Clara, CA 95054

Direct Telephone Calls to Silicon Valley Patent Group LLP
at telephone No. (408) 9828200

Full name of sole or first inventor

Shey-shi Lu

Inventor's signature

Shey-shi Lu

Date

Oct. 19, 2003

Residence

4 Fl.-1, No. 57-2, Lianyun St., Taipei, Taiwan 100, R.O.C.

Citizenship

A citizen of Taiwan, R.O.C.

Post Office Address

The same as above

Full name of second joint inventor, if any

Hung-Wei Chiu

Second Inventor's signature

Hung-Wei Chiu

Date

Oct 20, 2003

Residence

No. 48, Lane 294, Yanping N. Rd., Sec. 4, Taipei, Taiwan, 103 R.O.C.

Citizenship

A citizen of Taiwan, R.O.C.

Post Office Address

The same as above

(Supply similar information and signature for third and subsequent joint inventors.)

Full name of third joint inventor, if any	
Po-Wei Lee	
Third Inventor's signature	Date
Po-Wei Lee	Oct. 21, 2003
Residence	
4 Fl., No. 34-2, Lane 268, Fude St., Taipei, Taiwan 110, R.O.C.	
Citizenship	
A citizen of Taiwan, R.O.C.	
Post Office Address	
The same as above	
Full name of fourth joint inventor, if any	
Yu-Che Yang	
Fourth Inventor's signature	Date
Residence	
No. 31-5, Guangfu Rd., Sansing Shang, Yilan County, Taiwan, 266 R.O.C.	
Citizenship	
A citizen of Taiwan, R.O.C.	
Post Office Address	
The same as above	
Full name of fifth joint inventor, if any	
Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
Full name of sixth joint inventor, if any	
Second Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	

(Supply similar Information and signature for third and subsequent joint inventors.)

ATTACHMENT

ATTORNEYS OF Silicon Valley Patent Group LLP

David E. Steuber

Reg.No. 25,557

Michael J. Hablbert

Reg.No. 40,633

Omkar K. Suryadevara

Reg.No. 36,320

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(Number)	(Country)	(Day/Month/Year Filed)	Yes	No
_____	_____	_____	<input type="checkbox"/>	<input type="checkbox"/>
(Number)	(Country)	(Day/Month/Year Filed)	Yes	No

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of title 35, United States Code, § 112, I acknowledge the duty to disclose to the Office all information known to me to be material to patentability of the application as defined in Title 37, Code of Federal Regulations, § 1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)

(Filing Date)

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Inventor's signature	Date
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Citizenship	
A citizen of Taiwan, R.O.C.	
Post Office Address	
The same as above	
Full name of second joint inventor, if any	
Hung-Wei Chiu	
Second Inventor's signature	Date
Residence	
No. 48, Lane 294, Yanping N. Rd., Sec. 4, Taipei, Taiwan, 103 R.O.C.	
Citizenship	
A citizen of Taiwan, R.O.C.	
Post Office Address	
The same as above	

(Supply similar information and signature for third and subsequent joint inventors.)

Full name of third joint inventor, if any	
Po-Wei Lee	
Third Inventor's signature	Date
Residence	
4 Fl., No. 34-2, Lane 268, Fude St., Taipei, Taiwan 110, R.O.C.	
Citizenship	
A citizen of Taiwan, R.O.C.	
Post Office Address	
The same as above	
Full name of fourth joint inventor, if any	
Yu-Che Yang	
Fourth Inventor's signature	Date
<i>Yu-che Yang</i>	Nov. 8, 2003
Residence	
No. 31-5, Guangfu Rd., Sansing Shang, Yilan County, Taiwan, 266 R.O.C.	
Citizenship	
A citizen of Taiwan, R.O.C.	
Post Office Address	
The same as above	
Full name of fifth joint inventor, if any	
Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	
Full name of sixth joint inventor, if any	
Second Inventor's signature	Date
Residence	
Citizenship	
Post Office Address	

(Supply similar information and signature for third and subsequent joint inventors.)

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